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Orderable Parts for: MT29F16G08CBABAWP SEE ALL MLC NAND PARTS FBGA SPD Alternative Chipset Start Status Media PLP Code Validation Date Part Data VIEW MT29F16G08CBABAWP:B Obsolete N/A N/A N/A N/A No

Detailed Specifications

Density	16Gb	Status	Obsolete	NAND Type	2D	RoHS	Yes
Width	x8	Voltage	3.3V	Package	TSOP	Pin Count	48-pin
Op. Temp.	0C to +70C	MT/s		I/O	Common	Product Name	

Sim Models & Software

Sim Models

IBIS	
IBIS: NAND 16Gb MLC (Rev B) L62A (ZIP)	MLC NAND NAND Flash
Rev. 2.1	
File Type: ZIP Updated: 11/30/2012	DOWNLOAD
Verilog	
Verilog: NAND 16Gb, MLC (rev B) (ZIP)	MLC NAND NAND Flash
16Gb MLC NAND Verilog Model	
File Type: ZIP Updated: 12/31/2009	DOWNLOAD
Software	
Jortware	
Software Support Pack	
mtd-nand-use-a-lower-value-for-badblockbits-when-working-with-MLC-NAND (ZIP)	MLC NAND NAND Flash
MLC NANDs have more bit flips that SLC. When looking for bad block marker we have a lot of false positive if we check for the whole byte. To avoid this tolerate a few (4 here) bit flips for byte.	
File Type: ZIP Updated: 03/31/2016	DOWNLOAD
Software Support Pack	
NAND FLASH lockunlock bug fix (ZIP)	MLC NAND NAND Flash
Reset NAND before write protect check.	SLC NAND
File Type: ZIP Updated: 03/31/2016	DOWNLOAD
Software Support Pack	
fixup-ubi-cannot-recover-master node issue (ZIP)	MLC NAND NAND Flash
For MLC NAND, paired page issue is now a common known issue. This patch is just for master node cannot be recovered while there will two pages be dameged in one single master block.	
File Type: ZIP Updated: 03/31/2016	DOWNLOAD

MLC NAND UBI power loss issue for paired page Ver2.0 (ZIP) NAND Flash These patches aim to solve MLC NAND paired page power loss issue by adding a bakvol (backup volume) module in UBI layer. 70 series and 80 series families. DOWNLOAD File Type: ZIP Updated: 03/31/2016 **Software Support Pack** MLC NAND YAFFS mark bad block issue (ZIP) NAND Flash SLC NAND If the bitflips num over mtd->bitflip_threshold the mtd_read_oob will return -EUCLEAN and tags->ecc_result > YAFFS_ECC_RESULT_NO_ERROR. Then we will call yaffs_handle_chunk_error. DOWNLOAD File Type: ZIP Updated: 03/31/2016

RoHS Certificates

RoHS Certificates		
RoHS Certificate	of Compliance (PDF)	MT29F16G08CBABAWP
•	ation of how this product meets the requirements of the current DIRECTIVE estriction of Hazardous Substances (RoHS) Directive.	
File Type: (PDF)	Updated: 05/2017	DOWNLOAD
RoHS Certificates		
China RoHS Certi	icate (PDF)	MT29F16G08CBABAWP
Part-specific certific Electronic Informati	ation as required by China's Management Methods for Controlling Pollution by on Products.	
File Type: (PDF)	Updated: 05/2017	DOWNLOAD

Documentation & Support

See All MLC NAND Documentation

Technical Notes

SEARCH (4) MLC NAND TECHNICAL NOTES

Technical Notes

Downloaded from Arrow.com.

TN-00-33: Power Integrity Simulation with IBIS 5.0 Models (PDF)	3D NAND DDR3 SDRAM
	DDR4 SDRAM
(TN-00-33) This technical note describes the new features in IBIS 5.0 enabling F provides an overview of some of the modeling accuracy challenges and comparesults using various electronic design automation (EDA) software tools.	'I simulation. It also
File Type: PDF Updated: 01/25/2016	DOWNLOAD
Technical Notes	
TN-00-01: Moisture Sensitivity of Plastic Packages (PDF)	DDR SDRAM DDR2 SDRAM DDR3 SDRAM
(TN-00-01) This technical note describes shipping procedures for preventing m absorbing moisture and recommendations for baking devices exposed to excess	emory devices from DDR3L-RS
File Type: PDF Updated: 02/14/2013	DOWNLOAD
Technical Notes	
TN-29-65: Software Device Drivers for Very Large Page Micron NAND (PDF)	Flash Memory MLC NAND NAND Flash SLC NAND
(TN-29-65) Download the low-level driver described in this document here.	
File Type: PDF Updated: 10/15/2010	DOWNLOAD
Technical Notes	
TN-29-61: Wear Leveling in NAND Flash Memory (PDF)	MLC NAND NAND Flash SLC NAND
TN-29-61: Wear Leveling in NAND Flash Memory (PDF) (TN-29-61) This technical note describes the recommended wear leveling algorithm implemented in the FTL software for NAND Flash memory.	NAND Flash SLC NAND
(TN-29-61) This technical note describes the recommended wear leveling algor	NAND Flash SLC NAND
(TN-29-61) This technical note describes the recommended wear leveling algorized implemented in the FTL software for NAND Flash memory.	NAND Flash SLC NAND

Parts with the same Data Sheet (3)

		GG08CBABAWP	MT29F16G08CBABAC3	MT29F16G08CBABAL62A3W C1	MT29F16G08CBABAWP-IT		
	Status Obsolete		Obsolete	Obsolete	Obsolete		
	Density	16Gb	16Gb	16Gb	16Gb		
Dow	nloaded from Ar	row.com.					

	NAND Type	2D	2D	2D	2D		
	RoHS	Yes	Yes Yes		Yes		
	Width	x8	x8 x8		x8		
<	Voltage	3.3V	3.3V	3.3V	3.3V		
	Package	TSOP	ULGA	Wafer	TSOP		
	Pin Count	48-pin	52-pad	n/a	48-pin		
	Op. Temp.	0C to +70C	0C to +70C	0C to +70C	-40C to +85C		
	MT/s						
	VO Common		Common	Common	Common		
	Pr	oduct Name					

MT29F16G08CBABAWP

(Current)

Status	Obsolete		Where to Buy						
Density	16Gb		Where to buy						
NAND Type	2D	_							
RoHS	Yes	atus	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
Width	x8								
Voltage	3.3V	solete	N/A	N/A	N/A	N/A	No		VIEW
Package	TSOP								
Pin Count	48-pin								
Op. Temp.	0C to +70C		- OR - Check with Distributors						
		Your Region: Americas 💌							
I/O	Common								
Pr									
					Λ	wow			VIEW

See All Distributors

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